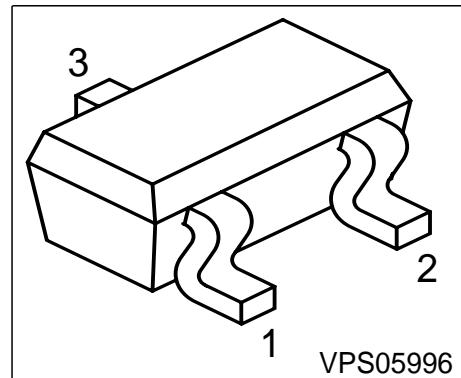


NPN Silicon RF Transistor

Preliminary data

- For low noise, high-gain broadband amplifiers at collector currents from 0.5 mA to 12 mA
- $f_T = 8$ GHz
- $F = 1.45$ dB at 900 MHz



ESD: Electrostatic discharge sensitive device, observe handling precaution!

Type	Marking	Pin Configuration			Package
BFR181T	RFs	1 = B	2 = E	3 = C	SC75

Maximum Ratings

Parameter	Symbol	Value	Unit
Collector-emitter voltage	V_{CEO}	12	V
Collector-emitter voltage	V_{CES}	20	
Collector-base voltage	V_{CBO}	20	
Emitter-base voltage	V_{EBO}	2	
Collector current	I_C	20	mA
Base current	I_B	2	
Total power dissipation $T_S \leq 79^\circ\text{C}^1)$	P_{tot}	175	mW
Junction temperature	T_j	150	$^\circ\text{C}$
Ambient temperature	T_A	-65 ... 150	
Storage temperature	T_{stg}	-65 ... 150	

Thermal Resistance

Junction - soldering point ²⁾	R_{thJS}	≤ 405	K/W
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¹ T_S is measured on the collector lead at the soldering point to the pcb

² For calculation of R_{thJA} please refer to Application Note Thermal Resistance

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
DC characteristics					
Collector-emitter breakdown voltage $I_C = 1 \text{ mA}, I_B = 0$	$V_{(\text{BR})\text{CEO}}$	12	-	-	V
Collector-emitter cutoff current $V_{CE} = 20 \text{ V}, V_{BE} = 0$	I_{CES}	-	-	100	μA
Collector-base cutoff current $V_{CB} = 10 \text{ V}, I_E = 0$	I_{CBO}	-	-	100	nA
Emitter-base cutoff current $V_{EB} = 1 \text{ V}, I_C = 0$	I_{EBO}	-	-	1	μA
DC current gain $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}$	h_{FE}	50	100	200	-

Electrical Characteristics at $T_A = 25^\circ\text{C}$, unless otherwise specified.

Parameter	Symbol	Values			Unit
		min.	typ.	max.	
AC characteristics (verified by random sampling)					
Transition frequency $I_C = 10 \text{ mA}, V_{CE} = 8 \text{ V}, f = 500 \text{ MHz}$	f_T	6	8	-	GHz
Collector-base capacitance $V_{CB} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{cb}	-	0.26	0.4	pF
Collector-emitter capacitance $V_{CE} = 10 \text{ V}, f = 1 \text{ MHz}$	C_{ce}	-	0.17	-	
Emitter-base capacitance $V_{EB} = 0.5 \text{ V}, f = 1 \text{ MHz}$	C_{eb}	-	0.3	-	
Noise figure $I_C = 2 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	F				dB
Power gain, maximum stable ¹⁾ $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 900 \text{ MHz}$	G_{ms}	-	19.5	-	
Power gain, maximum available ²⁾ $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_{\text{Sopt}}, Z_L = Z_{\text{Lopt}}, f = 1.8 \text{ GHz}$	G_{ma}	-	13.5	-	
Transducer gain $I_C = 5 \text{ mA}, V_{CE} = 8 \text{ V}, Z_S = Z_L = 50\Omega, f = 900 \text{ MHz}$ $f = 1.8 \text{ GHz}$	$ S_{21e} ^2$				

¹ $G_{ms} = |S_{21} / S_{12}|$

² $G_{ma} = |S_{21} / S_{12}| (k - (k^2 - 1)^{1/2})$

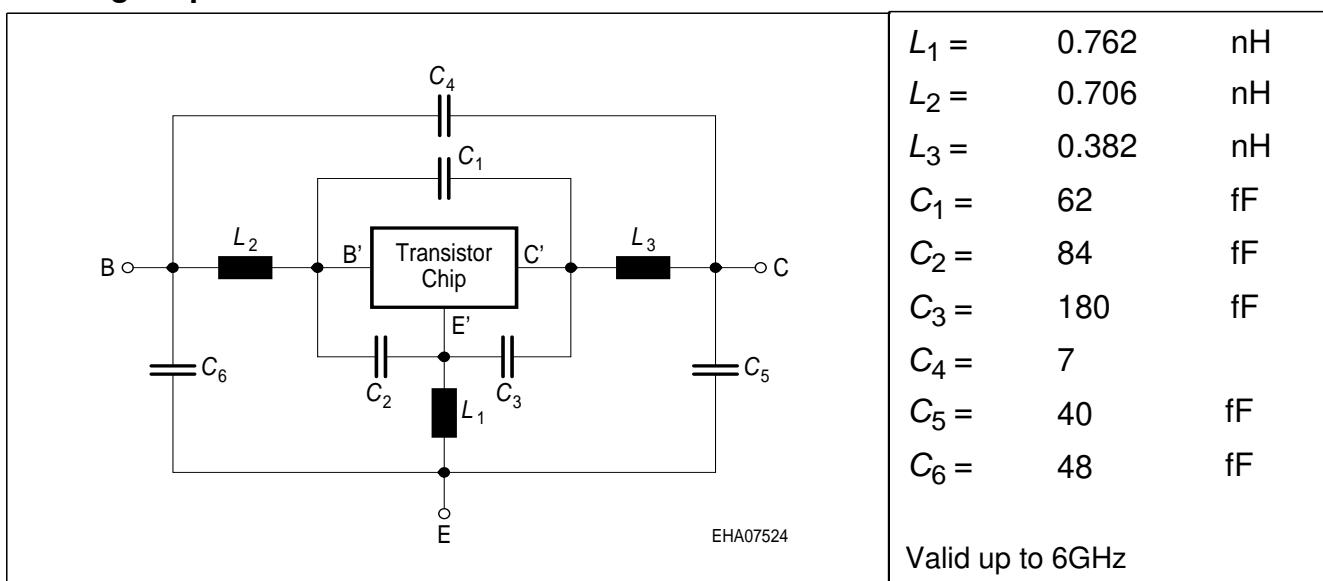
SPICE Parameters (Gummel-Poon Model, Berkley-SPICE 2G.6 Syntax) :
Transistor Chip Data

IS =	0.0010519 fA	BF =	96.461	-	NF =	0.90617	-
VAF =	22.403 V	IKF =	0.12146 A	A	ISE =	12.603 fA	fA
NE =	1.7631 -	BR =	16.504	-	NR =	0.87757	-
VAR =	5.1127 V	IKR =	0.24951 A	A	ISC =	0.01195 fA	fA
NC =	1.6528 -	RB =	9.9037 Ω	Ω	IRB =	0.69278 mA	mA
RBM =	6.6315 Ω	RE =	2.1372 Ω	Ω	RC =	2.2171 Ω	Ω
CJE =	1.8168 fF	VJE =	0.73155 V	V	MJE =	0.43619	-
TF =	17.028 ps	XTF =	0.33814	-	VTF =	0.12571 V	V
ITF =	1.0549 mA	PTF =	0 deg	deg	CJC =	319.69 fF	fF
VJC =	1.1633 V	MJC =	0.30013	-	XCJC =	0.082903	-
TR =	2.7449 ns	CJS =	0 fF	fF	VJS =	0.75 V	V
MJS =	0 -	XTB =	0	-	EG =	1.11 eV	eV
XTI =	3 -	FC =	0.99768	-	TNOM	300 K	K

All parameters are ready to use, no scaling is necessary.

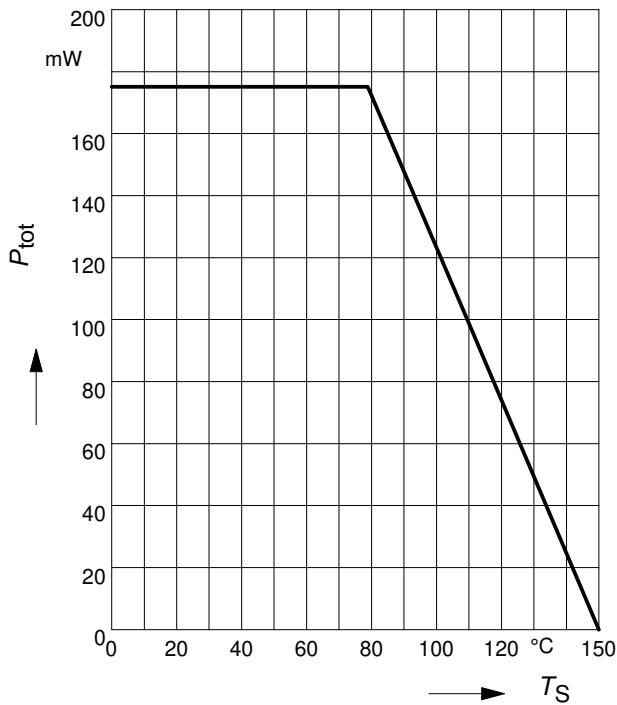
Extracted on behalf of Infineon Technologies AG by:

Institut für Mobil- und Satellitentechnik (IMST)

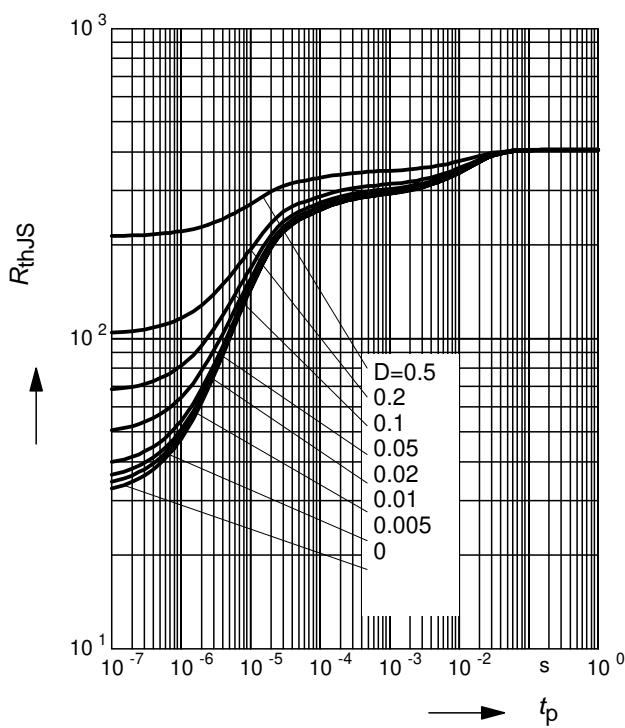
Package Equivalent Circuit:


For examples and ready to use parameters please contact your local Infineon Technologies distributor or sales office to obtain a Infineon Technologies CD-ROM or see Internet: <http://www.infineon.com/silicondiscretes>

Total power dissipation $P_{\text{tot}} = f(T_S)$

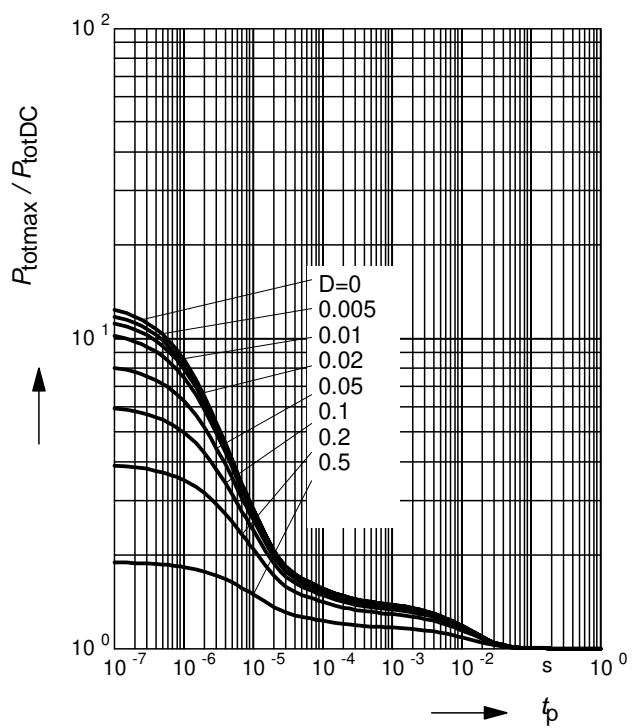


Permissible Pulse Load $R_{\text{thJS}} = f(t_p)$

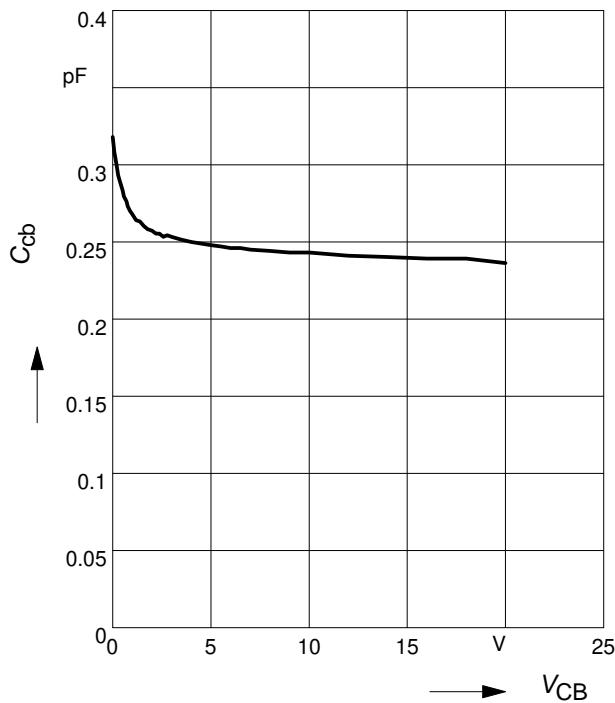


Permissible Pulse Load

$P_{\text{totmax}}/P_{\text{totDC}} = f(t_p)$

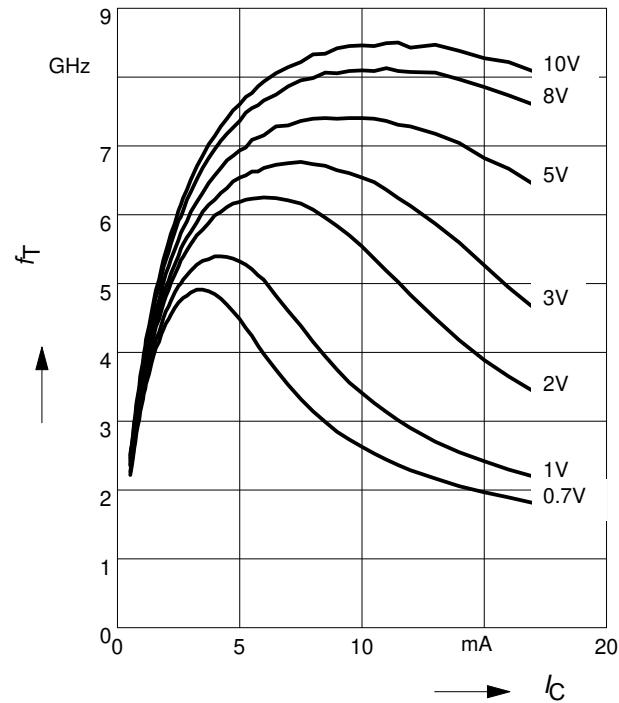


Collector-base capacitance $C_{cb} = f(V_{CB})$
 $f = 1\text{MHz}$

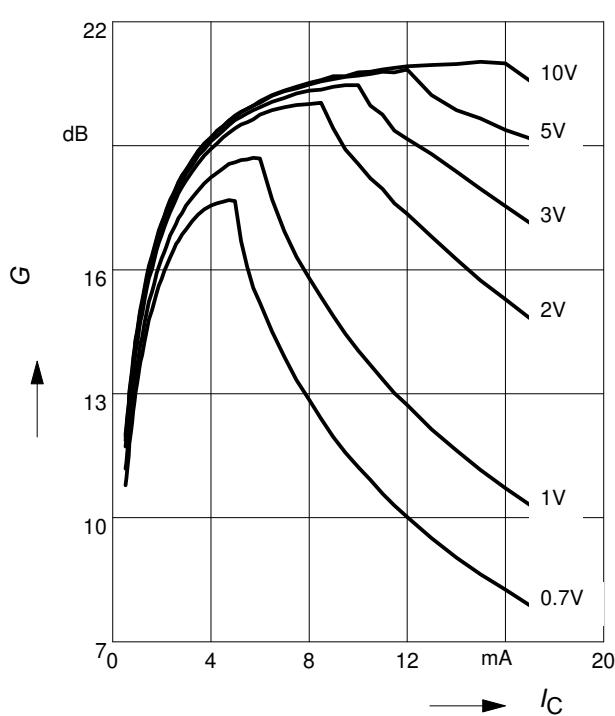


Transition frequency $f_T = f(I_C)$

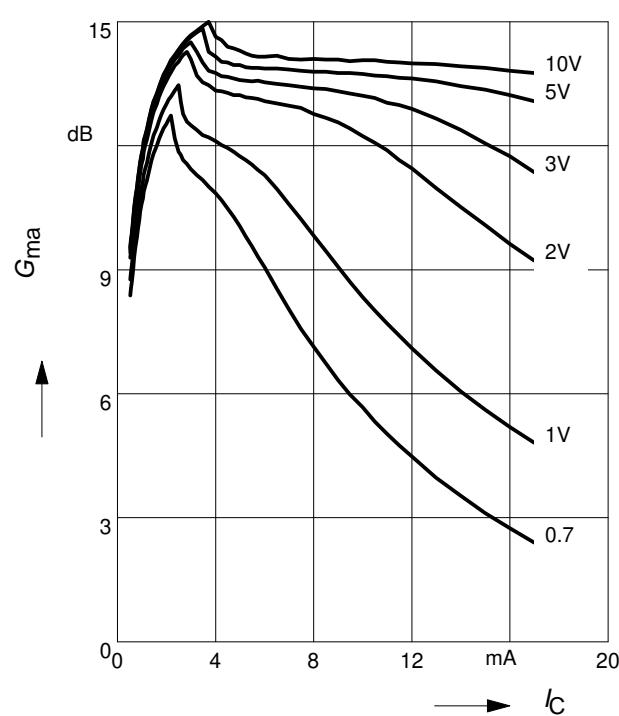
$V_{CE} = \text{Parameter}$



Power Gain $G_{ma}, G_{ms} = f(I_C)$
 $f = 0.9\text{GHz}$
 $V_{CE} = \text{Parameter}$

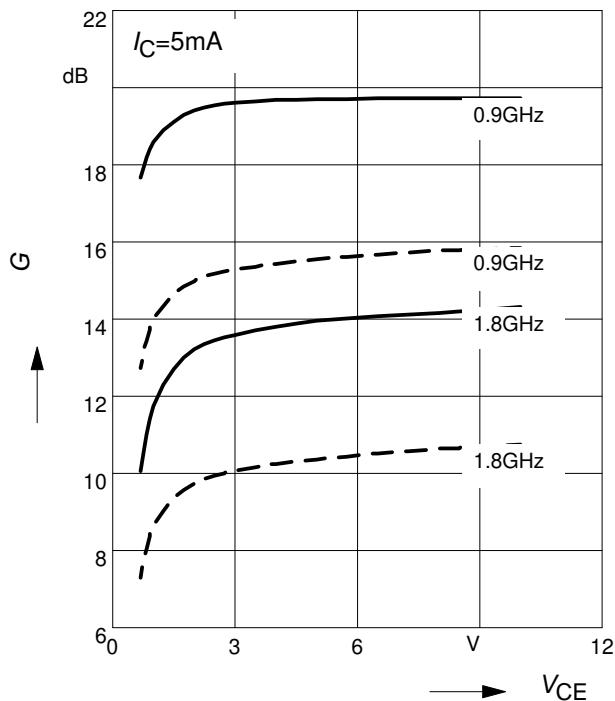


Power Gain $G_{ma}, G_{ms} = f(I_C)$
 $f = 1.8\text{GHz}$
 $V_{CE} = \text{Parameter}$



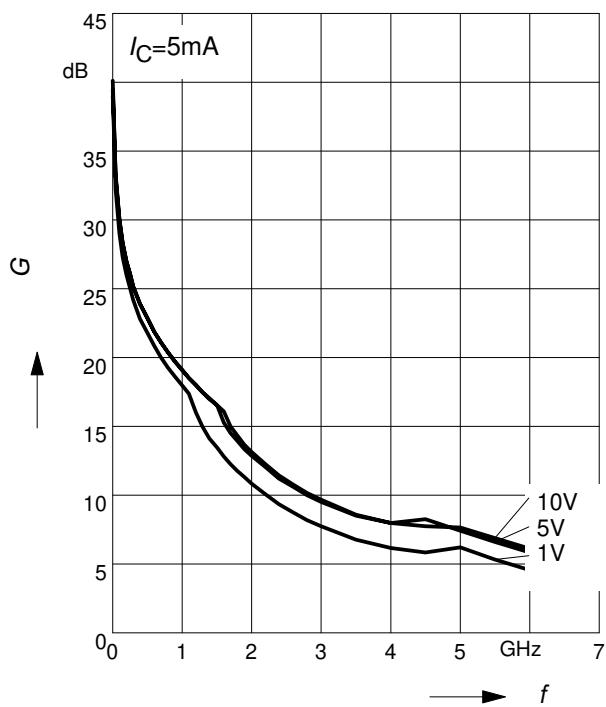
Power Gain G_{ma} , $G_{ms} = f(V_{CE})$:
 $|S_{21}|^2 = f(V_{CE})$:

f = Parameter

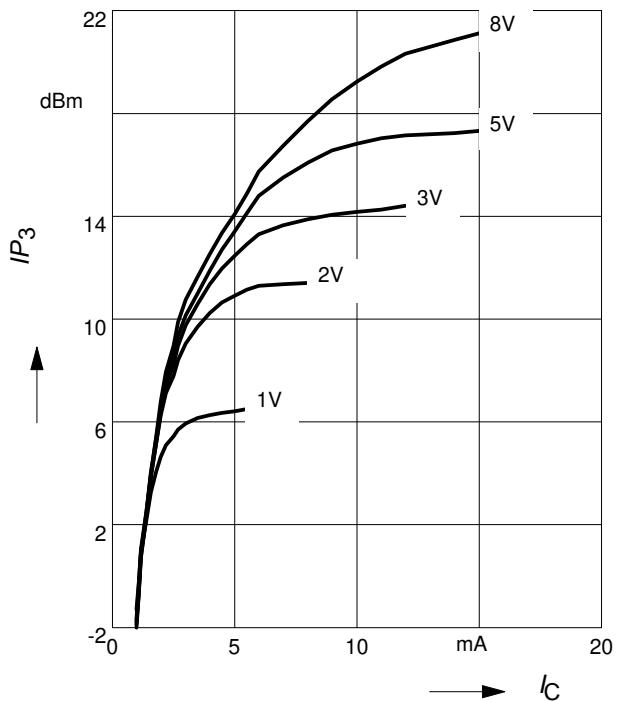


Power Gain G_{ma} , $G_{ms} = f(f)$

V_{CE} = Parameter



Intermodulation Intercept Point $IP_3 = f(I_C)$
(3rd order, Output, $Z_S = Z_L = 50\Omega$)
 V_{CE} = Parameter, $f = 900\text{MHz}$



Power Gain $|S_{21}|^2 = f(f)$

V_{CE} = Parameter

